## SKiM 300GD126DL



SKiM<sup>®</sup> 4

### **IGBT Modules**

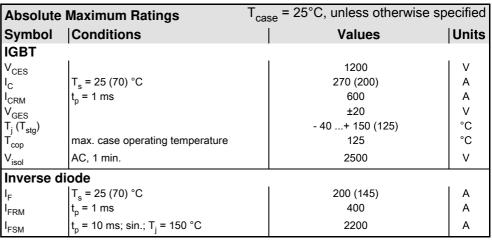
#### **SKIM 300GD126DL**

#### **Features**

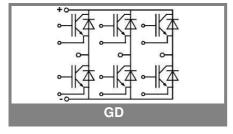
- Trench gate IGBT with field stop layer
- · Low inductance case
- . Fast & soft inverse CAL diode
- Isolated by Al<sub>2</sub>O<sub>3</sub> DCB (Direct Copper Bonded) ceramic plate
- Pressure contact technology for thermal contacts
- Spring contact system to attach driver PCB to the control terminals
- Integrated temperature sensor

#### Typical Applications\*

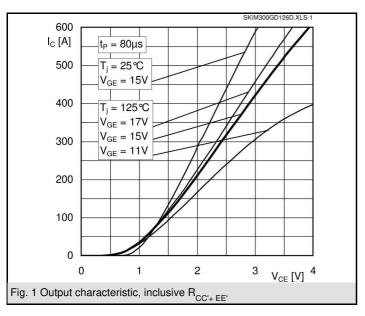
- Switched mode power supplies
- Three phase inverters for AC motor speed control
- Switching (not for linear use)

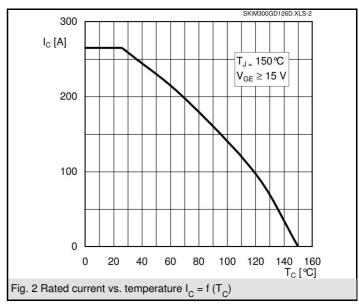


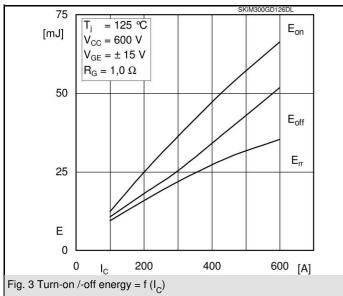
Characte	eristics T <sub>cas</sub>	<sub>e</sub> = 25°C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					•
$V_{GE(th)}$	$V_{GE} = V_{CE}$ ; $I_C = 12 \text{ mA}$	5	5,8	6,5	V
I <sub>CES</sub>	$V_{GE} = 0; V_{CE} = V_{CES};$ $T_{i} = 25 °C$			3,6	mA
$V_{CEO}$	T <sub>j</sub> = 25 (125) °C		1 (0,9)	1,2 (1,1)	V
$r_{CE}$	T <sub>j</sub> = 25 (125) °C		2,2 (3,5)	3 (4,3)	mΩ
$V_{CEsat}$	$I_{Cnom} = 300 \text{ A}; V_{GE} = 15 \text{ V},$		1,65 (1,95)	2,1 (2,4)	V
	T <sub>j</sub> = 25 (125) °C on chip level				
C <sub>ies</sub>	V <sub>GE</sub> = 0; V <sub>CE</sub> = 25 V; f = 1 MHz		22,5		nF
C <sub>oes</sub>	$V_{GE} = 0; V_{CE} = 25 V; f = 1 MHz$		1,8		nF
C <sub>res</sub>	$V_{GE} = 0$ ; $V_{CE} = 25 \text{ V}$ ; $f = 1 \text{ MHz}$		1,65		nF
L <sub>CE</sub>			10	15	nH
R <sub>CC'+EE'</sub>	resistance, terminal-chip T <sub>c</sub> = 25 (125) °C		1,35 (1,75)		mΩ
t <sub>d(on)</sub>	V <sub>CC</sub> = 600 V		285		ns
t <sub>r</sub>	I <sub>Cnom</sub> = 300 A		45		ns
$t_{d(off)}$	$R_{Gon} = R_{Goff} = 1 \Omega$		580		ns
t <sub>f</sub>	T <sub>j</sub> = 125 °C		95		ns
E <sub>on</sub> (E <sub>off</sub> )	V <sub>GE</sub> ± 15 V		25 (36)		mJ
$E_{on} \left( E_{off} \right)$	with SKHI 6; T <sub>j</sub> = °C				mJ
	$V_{CC} = V; I_C = A$				
Inverse o			- ()	,,	
$V_F = V_{EC}$	I <sub>Fnom</sub> = 200 A; V <sub>GE</sub> = 0 V; T <sub>j</sub> = 25 (125) °C		2 (1,8)	2,5 (2,3)	V
$V_{TO}$	T <sub>j</sub> = 25 (125) °C		1,1 (0,85)	1,45 (1,2)	V
r <sub>T</sub>	$T_j = 25 (125) ^{\circ}C$		4,5 (4,8)	5,3 (5,5)	mΩ
I <sub>RRM</sub>	$I_F = 300 \text{ A; } T_j = 125 \text{ °C}$		450		A
Q <sub>rr</sub>	V <sub>GE</sub> = 0 V di/dt = 11000 A/μs		47		μC
E <sub>rr</sub>	$R_{Gon} = R_{Goff} = 1 \Omega$		22		mJ
	characteristics				1
$R_{th(j-s)}$	per IGBT			0,2	K/W
$R_{th(j-s)}$	per FWD			0,285	K/W
•	ture Sensor				
$R_{TS}$	T = 25 (100) °C		1 (1,67)		kΩ
tolerance	T = 25 (100) °C		3 (2)		%
Mechani	cal data				
M <sub>1</sub>	to heatsink (M5)	2		3	Nm
$M_2$	for terminals (M6)	4		5	Nm
w				310	g

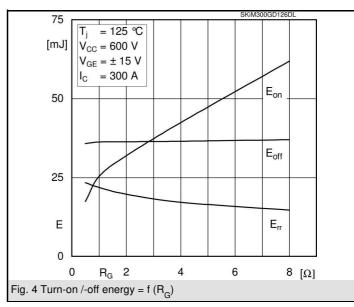


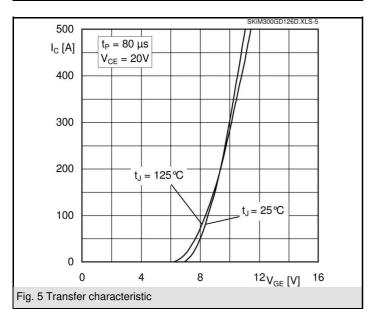
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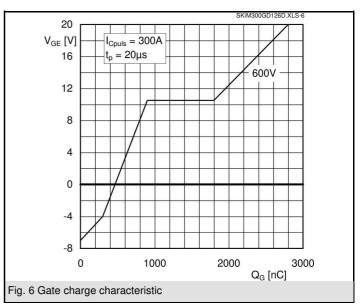




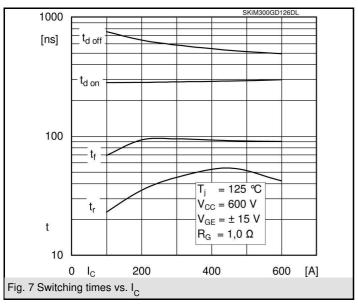


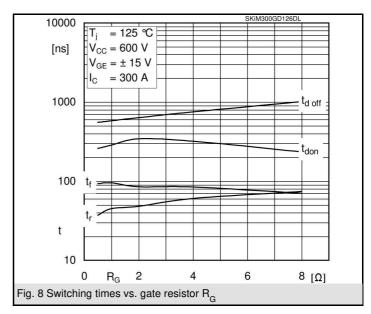


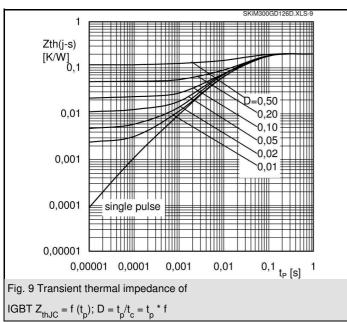


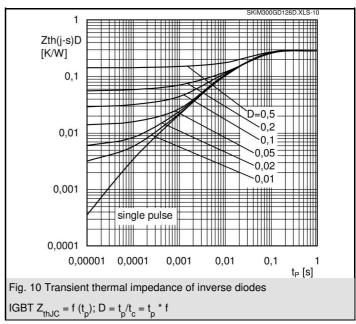


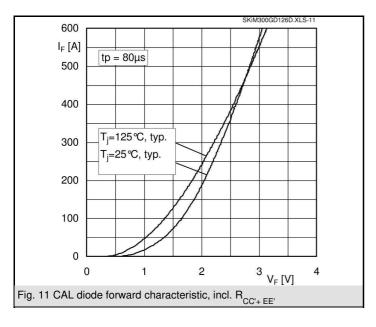
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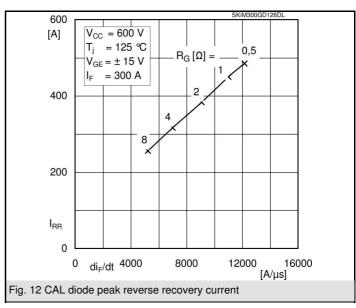




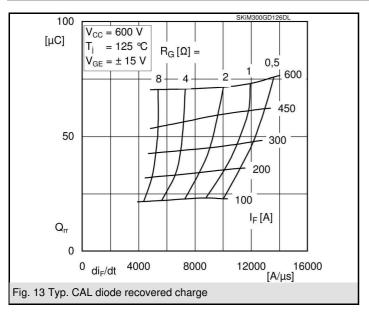


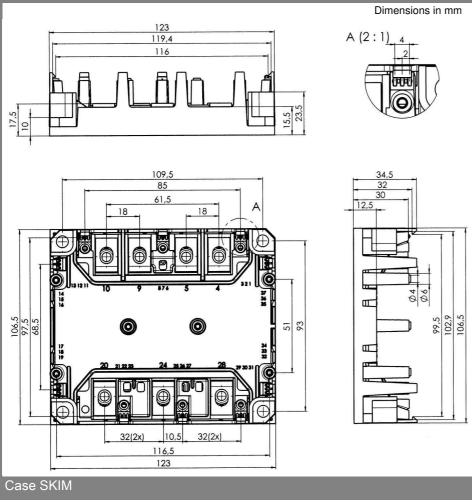


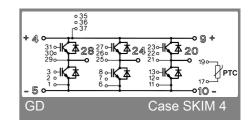




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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

#### \*IMPORTANT INFORMATION AND WARNINGS

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